

## DESCRIPTION

The JUB05CD2 is a bi-directional TVS diode, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive data and power line. The JUB05CD2 complies with the IEC 61000-4-2 (ESD) standard with  $\pm 15$  kV air and  $\pm 8$  kV contact discharge. It is assembled into an ultra-small 1.0x0.6x0.5mm lead-free 0402 package. The small size and high ESD surge protection make JUB05CD2 an ideal choice to protect cell phone, digital cameras, audio players and many other portable applications.

## APPLICATIONS

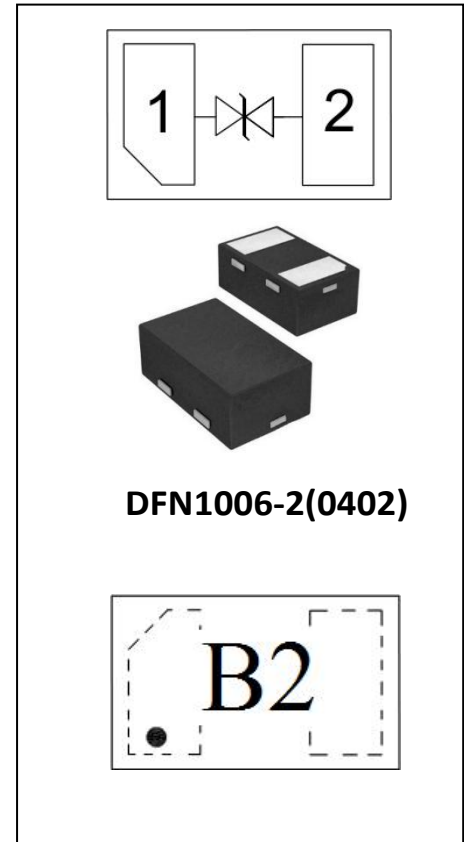
- ✧ Cellular Handsets and Accessories.
- ✧ Personal Digital Assistants.
- ✧ Notebooks and Handhelds.
- ✧ Portable Instrumentation.
- ✧ Digital Cameras.
- ✧ Peripherals.
- ✧ Audio Players.
- ✧ Keypads, Side Keys, LCD Displays.

## FEATURES

- ✧ Ultra small package: 1.0x0.6x0.5mm.
- ✧ Ultra low capacitance: 15pF typical.
- ✧ Ultra low leakage: nA level.
- ✧ Low operating voltage: 5V.
- ✧ Low clamping voltage.
- ✧ 2-pin leadless package.
- ✧ Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test
    - Air discharge:  $\pm 30$  kV
    - Contact discharge:  $\pm 30$  kV
  - IEC61000-4-5 (Lightning) 8A (8/20 $\mu$ s).
- ✧ RoHS Compliant.

## MECHANICAL CHARACTERISTICS

- ✧ DFN1006-2(0402) Package.
- ✧ Quantity Per Reel : 10,000pcs.
- ✧ Reel Size : 7 inch.



**DEVICE CHARACTERISTICS**
**Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise specified)**

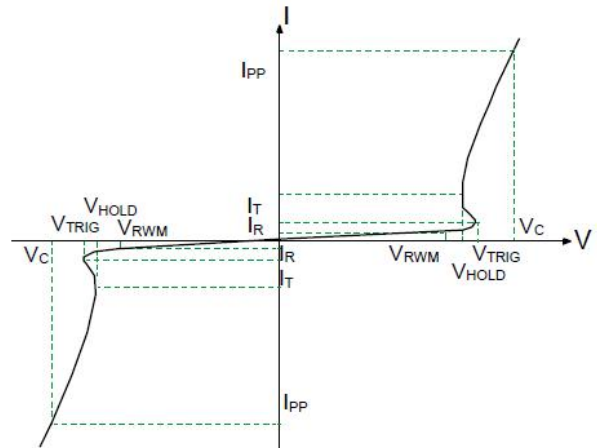
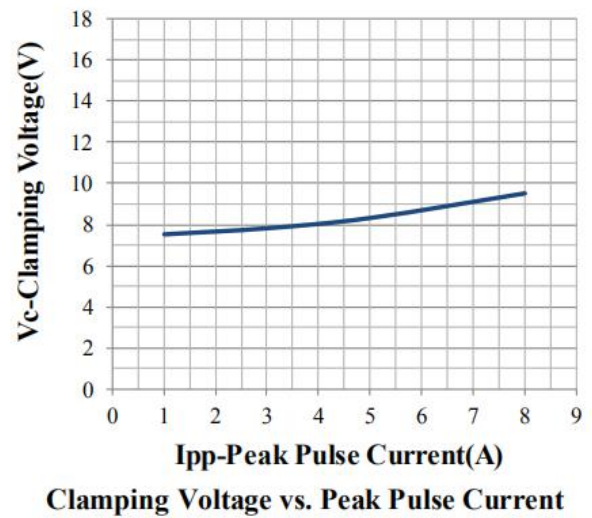
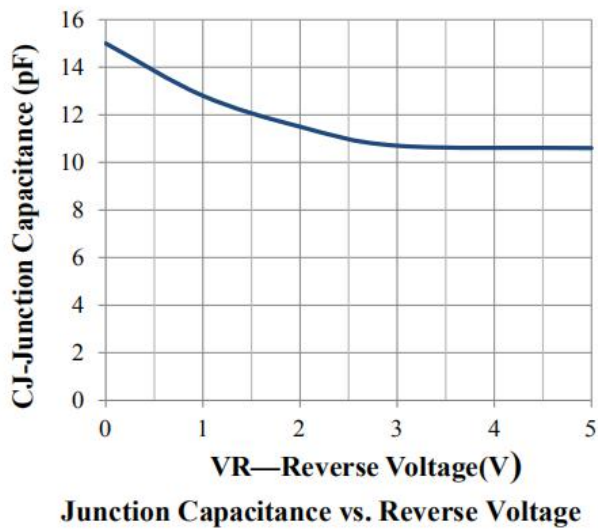
Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 $\mu\text{s}$ )	Ppk	110	W
Peak Pulse Current (8/20 $\mu\text{s}$ )	IPP	8	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm 30$	kV
ESD per IEC 61000-4-2 (Contact)		$\pm 30$	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}\text{C}$

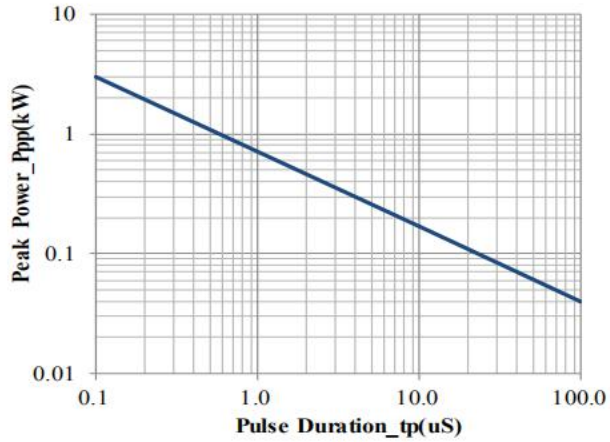
**ELECTRICAL CHARACTERISTICS( $T_A=25^{\circ}\text{C}$  unless otherwise specified)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	$V_{\text{RWM}}$				5.0	V
Breakdown Voltage	$V_{\text{BR}}$	$I_T = 1\text{mA}$	6.0			V
Reverse Leakage Current	$I_R$	$V_{\text{RWM}} = 5.0\text{V}$			0.5	$\mu\text{A}$
Clamping Voltage	$V_C$	$I_{\text{PP}} = 1\text{A}$ (8 x 20 $\mu\text{s}$ pulse)			7.5	V
Clamping Voltage	$V_C$	$I_{\text{PP}} = 8\text{A}$ (8 x 20 $\mu\text{s}$ pulse)		9.0	13	V
Junction Capacitance	$C_J$	$V_R = 0\text{V}$ , $f = 1\text{MHz}$		15	18	pF

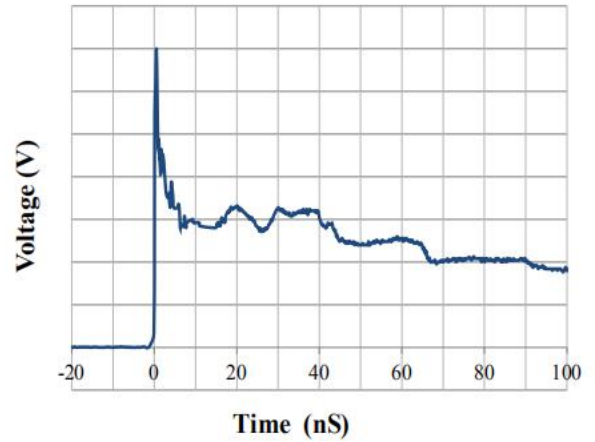
**ELECTRICAL PARAMETER**

Symbol	Parameter
$V_{RWM}$	Peak Reverse Working Voltage
$I_R$	Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_T$	Test Current
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$

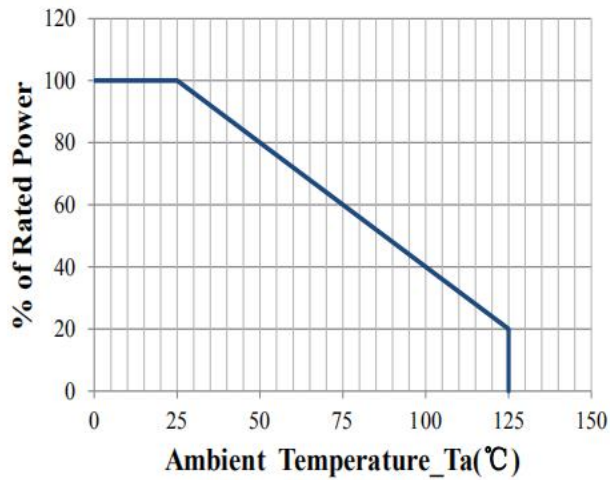

**TYPICAL CHARACTERISTICS**( $T_A=25^\circ\text{C}$  unless otherwise Specified)




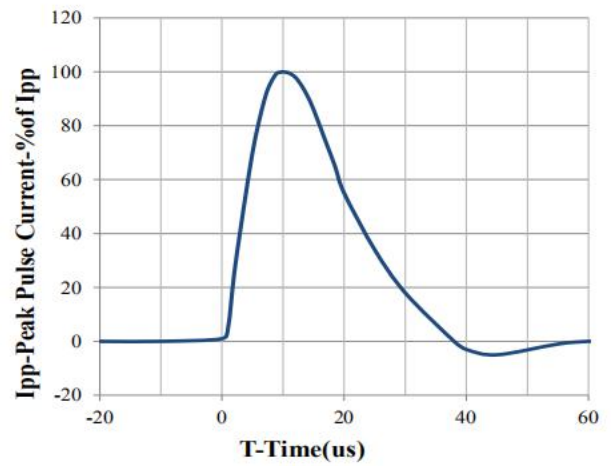
**Peak Pulse Power vs. Pulse Time**



**IEC61000-4-2 Pulse Waveform**

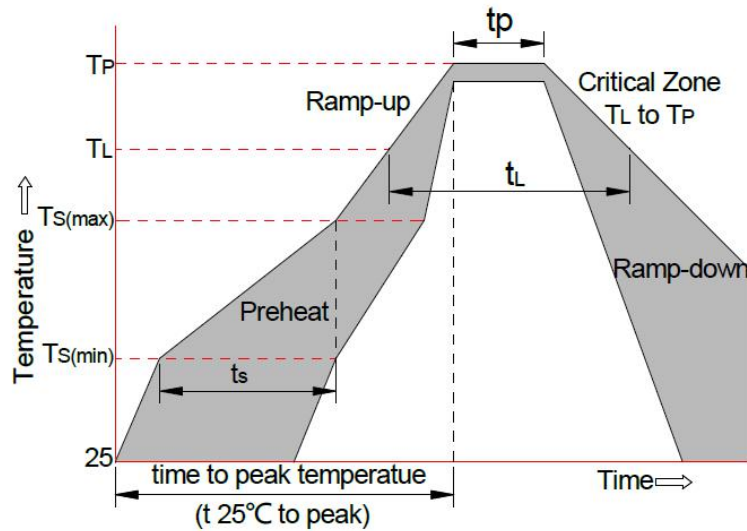


**Power Derating Curve**

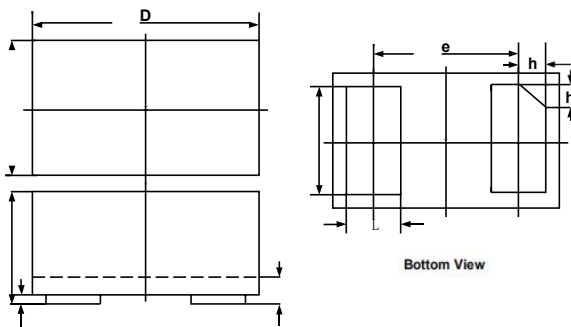


**8 X 20us Pulse Waveform**

## SOLDERING PARAMETERS

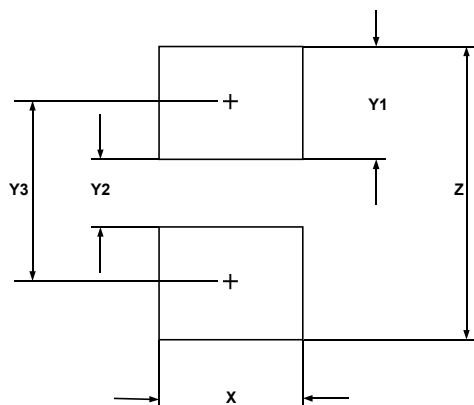


Reflow Condition		Pb-Free Assembly
Pre-heat	-Temperature Min ( $T_{s (min)}$ )	+150°C
	-Temperature Max ( $T_{s (max)}$ )	+200°C
	-Time (Min to Max) ( $t_s$ )	60-180 secs
Average ramp up rate( Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s (max)}$ to $T_L$ -Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature ( $T_L$ ) (Liquid us)	+217°C
	-Temperature ( $t_L$ )	60-150 secs
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6 °C/secs. Max
xTime 25°C to Peak Temp ( $T_P$ )		8 min. Max
Do not exceed		+260°C

**DFN1006-2(0402) PACKAGE OUTLINE & DIMENSIONS**


SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.45	0.50	0.55	0.018	0.020	0.022
c	0.12	0.15	0.18	0.005	0.006	0.007
D	0.95	1.00	1.05	0.037	0.039	0.041
e	0.65 BSC			0.026 BSC		
E	0.55	0.60	0.65	0.022	0.024	0.026
L	0.20	0.25	0.30	0.008	0.010	0.012
h	0.07	0.12	0.17	0.003	0.005	0.007

**SUGGESTED LAND PATTERN**



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
X	0.60	0.024
Y1	0.50	0.020
Y2	0.30	0.012
Y3	0.80	0.032
Z	1.30	0.052

Website: <http://www.jksemi.com>

For additional information, please contact your local Sales Representative.

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